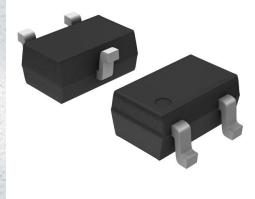


MUN5115T1G Datasheet

www.digi-electronics.com



DiGi Electronics Part Number	MUN5115T1G-DG
Manufacturer	onsemi
Manufacturer Product Number	MUN5115T1G
Description	TRANS PREBIAS PNP 50V SC70-3
Detailed Description	Pre-Biased Bipolar Transistor (BJT) PNP - Pre-Biase d 50 V 100 mA 202 mW Surface Mount SC-70-3 (SO T323)

https://www.DiGi-Electronics.com



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
MUN5115T1G	onsemi
Series:	Product Status:
-	Active
Transistor Type:	Current - Collector (Ic) (Max):
PNP - Pre-Biased	100 mA
Voltage - Collector Emitter Breakdown (Max):	Resistor - Base (R1):
50 V	10 kOhms
DC Current Gain (hFE) (Min) @ lc, Vce:	Vce Saturation (Max) @ lb, lc:
160 @ 5mA, 10V	250mV @ 300μA, 10mA
Current - Collector Cutoff (Max):	Power - Max:
500nA	202 mW
Mounting Type:	Package / Case:
Surface Mount	SC-70, SOT-323
Supplier Device Package:	Base Product Number:
SC-70-3 (SOT323)	MUN5115

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.21.0095	

onsemi

Digital Transistors (BRT) R1 = 10 k Ω , **R2 =** ∞ **k** Ω

PNP Transistors with Monolithic Bias Resistor Network

MUN2115, MMUN2115L, MUN5115, DTA114TE, DTA114TM3, NSBA114TF3

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

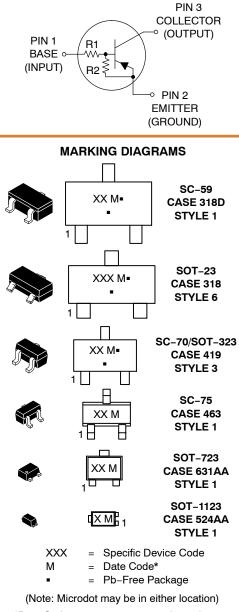
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count

MAXIMUM BATINGS $(T_A = 25^{\circ}C)$

- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Rating	Symbol	Max	Unit		
Collector-Base Voltage	V _{CBO}	50	Vdc		
Collector-Emitter Voltage	V _{CEO}	50	Vdc		
Collector Current – Continuous	Ι _C	100	mAdc		
Input Forward Voltage	V _{IN(fwd)}	40	Vdc		
Input Reverse Voltage	V _{IN(rev)}	5	Vdc		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



PIN CONNECTIONS

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering, marking, and shipping information on page 2 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 2.

Table 1. ORDERING INFORMATION

Device	Part Marking	Package	Shipping [†]
MUN2115T1G	6E	SC–59 (Pb–Free)	3000 / Tape & Reel
MMUN2115LT1G	A6E	SOT-23 (Pb-Free)	3000 / Tape & Reel
MUN5115T1G, SMUN5115T1G	6E	SC-70/SOT-323 (Pb-Free)	3000 / Tape & Reel

DISCONTINUED (Note 1)

DTA114TET1G	6E	SC–75 (Pb–Free)	3000 / Tape & Reel
DTA114TM3T5G	6E	SOT-723 (Pb-Free)	8000 / Tape & Reel
NSBA114TF3T5G	L (90°)*	SOT-1123 (Pb-Free)	8000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

 $(xx^{\circ}) =$ Degree rotation in the clockwise direction.

1. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

(1) SC-75 and SC-70/SOT-323; Minimum Pad

(4) SOT-1123; 100 mm², 1 oz. copper trace

(2) SC-59; Minimum Pad

(3) SOT-23; Minimum Pad

(5) SOT-723; Minimum Pad

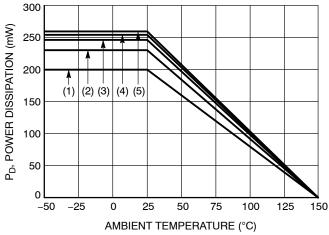


Figure 1. Derating Curve

Table 2. THERMAL CHARACTERISTICS

	Characteristic	Symbol	Мах	Unit
THERMAL CHARACTERI	STICS (SC-59) (MUN2115)			
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C	(Note 2) (Note 3) (Note 2)	PD	230 338 1.8	mW mW/°C
Thermal Resistance,	(Note 3) (Note 2)	R _{θJA}	2.7 540	°C/W
Junction to Ambient	(Note 3)		370	
Thermal Resistance, Junction to Lead	(Note 2) (Note 3)	R _{θJL}	264 287	°C/W
Junction and Storage Temp	0	T _J , T _{stg}	–55 to +150	°C
THERMAL CHARACTER	STICS (SOT-23) (MMUN2115L)			
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	(Note 2) (Note 3) (Note 2)	PD	246 400 2.0	mW mW/°C
Thermal Resistance, Junction to Ambient	(Note 3) (Note 1) (Note 3)	R _{θJA}	3.2 508 311	°C/W
Thermal Resistance, Junction to Lead	(Note 2) (Note 3)	R _{θJL}	174 208	°C/W
Junction and Storage Tem		T _J , T _{stg}	-55 to +150	°C
	STICS (SC-70/SOT-323) (MUN5115)	0. Olg		
Total Device Dissipation		PD		
$T_A = 25^{\circ}C$ Derate above 25°C	(Note 2) (Note 3) (Note 2) (Note 3)		202 310 1.6 2.5	mW mW/°C
Thermal Resistance, Junction to Ambient	(Note 2) (Note 3)	R _{θJA}	618 403	°C/W
Thermal Resistance, Junction to Lead	(Note 2) (Note 3)	R _{θJL}	280 332	°C/W
Junction and Storage Tem	perature Range	T _J , T _{stg}	-55 to +150	°C
THERMAL CHARACTERI	STICS (SC-75) (DTA114TE)			
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C	(Note 2) (Note 3) (Note 2)	PD	200 300 1.6	mW mW/°C
Thermal Resistance, Junction to Ambient	(Note 3) (Note 2) (Note 3)	R _{θJA}	2.4 600 400	°C/W
Junction and Storage Tem		T _J , T _{stg}	-55 to +150	°C
0 .	STICS (SOT-723) (DTA114TM3)	. J, . SQ		-
Total Device Dissipation $T_A = 25^{\circ}C$	(Note 2)	P _D	260	mW
Derate above 25°C	(Note 3) (Note 2) (Note 3)		600 2.0 4.8	mW/°C
Thermal Resistance, Junction to Ambient	(Note 2) (Note 3)	R _{0JA}	480 205	°C/W

2. FR-4 @ Minimum Pad.

3. FR-4 @ 1.0 x 1.0 Inch Pad.

FR-4 @ 100 mm², 1 oz. copper traces, still air.
FR-4 @ 500 mm², 1 oz. copper traces, still air.

Table 2. THERMAL CHARACTERISTICS

Characteristic			Max	Unit
THERMAL CHARACTERISTICS (SOT-723) (DTA114TM3	3)			
Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C
THERMAL CHARACTERISTICS (SOT-1123) (NSBA114T	F3)			
Total Device Dissipation T _A = 25°C (Note 4) (Note 5) Derate above 25°C (Note 4) (Note 5)		P _D	254 297 2.0 2.4	mW mW/°C
Thermal Resistance,(Note 4)Junction to Ambient(Note 5)		R_{\thetaJA}	493 421	°C/W
Thermal Resistance, Junction to Lead	(Note 4)	$R_{ ext{ heta}JL}$	193	°C/W
Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C

2. FR-4 @ Minimum Pad.

FR-4 @ 1.0 x 1.0 Inch Pad.
FR-4 @ 100 mm², 1 oz. copper traces, still air.
FR-4 @ 500 mm², 1 oz. copper traces, still air.

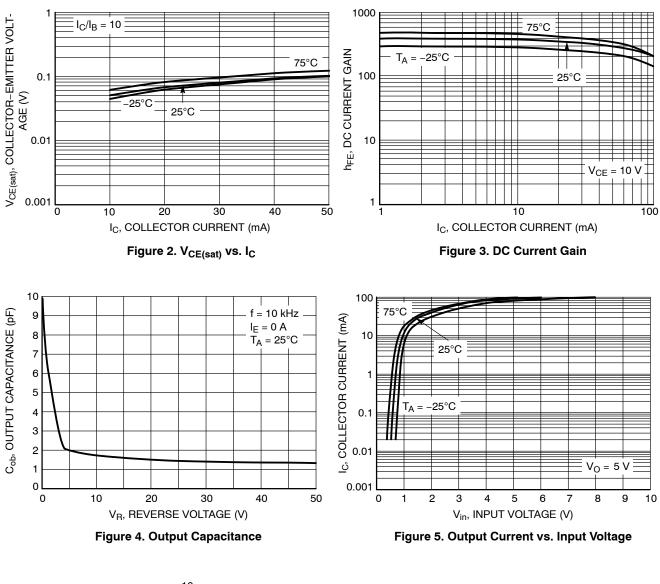
Table 3. ELECTRICAL CHARACTERISTICS (T_A = 25°C, unless otherwise noted)

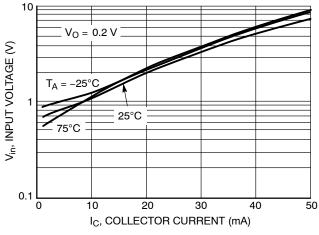
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector-Base Cutoff Current $(V_{CB} = 50 \text{ V}, I_E = 0)$	I _{CBO}	_	_	100	nAdc
Collector–Emitter Cutoff Current ($V_{CE} = 50 \text{ V}, I_B = 0$)	I _{CEO}	_	_	500	nAdc
Emitter-Base Cutoff Current ($V_{EB} = 6.0 \text{ V}, I_C = 0$)	I _{EBO}	-	_	0.9	mAdc
Collector-Base Breakdown Voltage $(I_C = 10 \ \mu A, I_E = 0)$	V _(BR) CBO	50	_	_	Vdc
Collector-Emitter Breakdown Voltage (Note 6) $(I_{C} = 2.0 \text{ mA}, I_{B} = 0)$	V _{(BR)CEO}	50	_	-	Vdc
ON CHARACTERISTICS					
DC Current Gain (Note 6) (I _C = 5.0 mA, V _{CE} = 10 V)	h _{FE}	160	250	-	
Collector-Emitter Saturation Voltage (Note 6) $(I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA})$	V _{CE(sat)}	_	-	0.25	Vdc
Input Voltage (off) $(V_{CE} = 5.0 \text{ V}, I_C = 100 \ \mu\text{A})$	V _{i(off)}	_	0.6	0.5	Vdc
Input Voltage (on) (V _{CE} = 0.3 V, I _C = 10 mA)	V _{i(on)}	1.7	1.2	-	Vdc
Output Voltage (on) (V _{CC} = 5.0 V, V _B = 2.5 V, R _L = 1.0 k Ω)	V _{OL}	_	_	0.2	Vdc
Output Voltage (off) (V _{CC} = 5.0 V, V _B = 0.25 V, R _L = 1.0 k Ω)	V _{OH}	4.9	_	-	Vdc
Input Resistor	R1	7.0	10	13	kΩ
Resistor Ratio	R ₁ /R ₂	-	-	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle ≤ 2%.

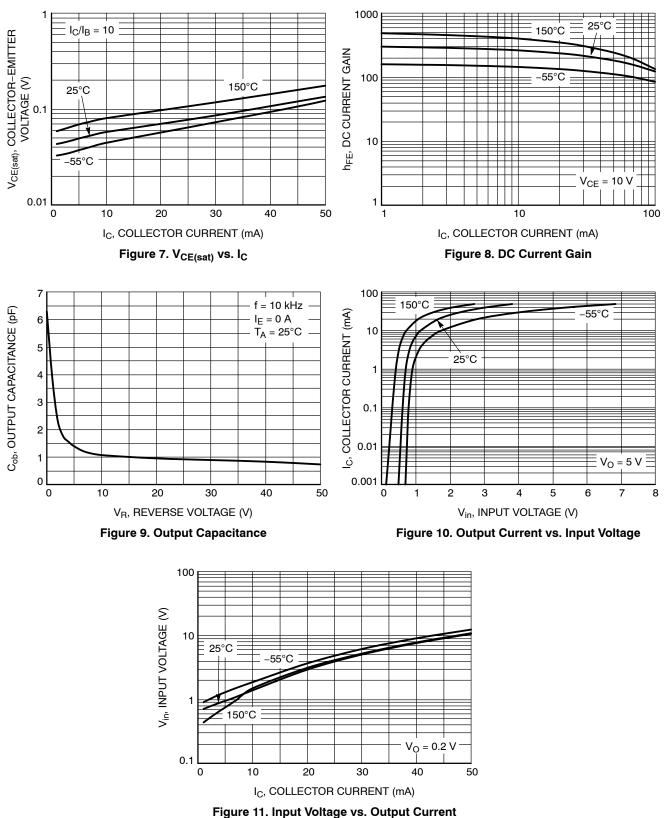
TYPICAL CHARACTERISTICS MUN2115, MMUN2115L, MUN5115, DTA114TE, DTA114TM3



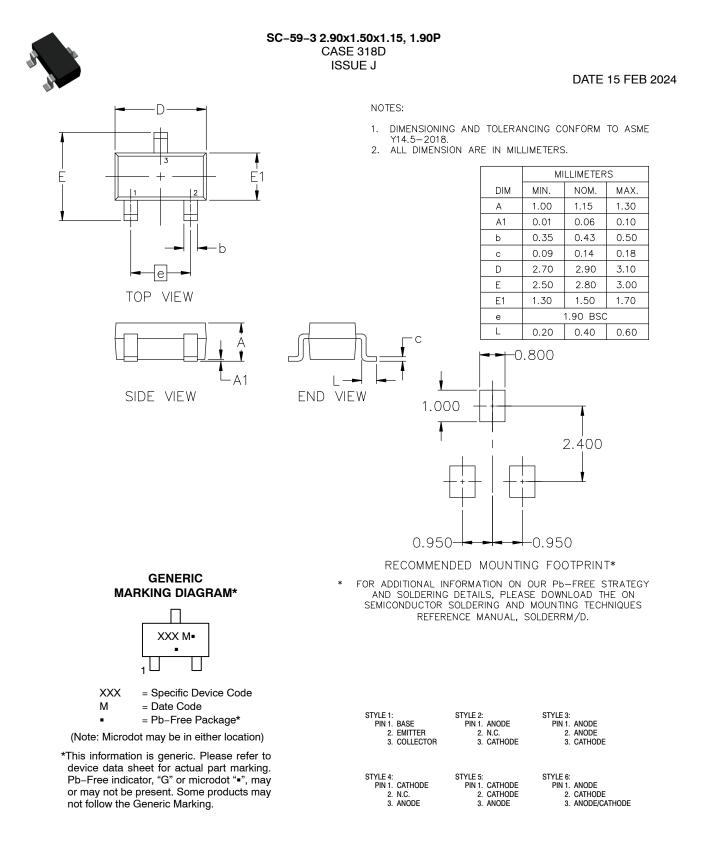








PACKAGE DIMENSIONS



SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318 ISSUE AU**



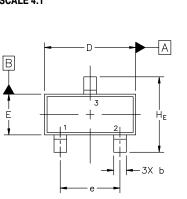
MECHANICAL CASE OUTLINE

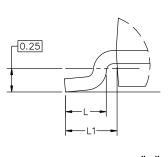
PACKAGE DIMENSIONS

DATE 14 AUG 2024

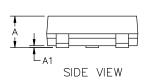


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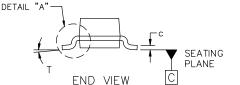


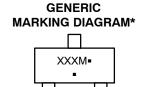






TOP VIEW

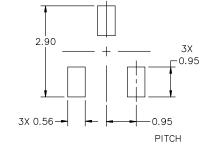




XXX = Specific Device Code Μ = Date Code

= Pb-Free Package .

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



MILLIMETERS				
DIM	MIN	NOM	МАХ	
А	0.89	1.00	1.11	
A1	0.01	0.06	0.10	
b	0.37	0.44	0.50	
С	0.08	0.14	0.20	
D	2.80	2.90	3.04	
E	1.20	1.30	1.40	
е	1.78	1.90	2.04	
L	0.30	0.43	0.55	
L1	0.35	0.54	0.69	
ΗE	2.10	2.40	2.64	
Т	0°		10°	

NOTES:

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS: 1.

2.

CONTROLLING DIMENSIONS: MILLIMETERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PPOTPUSIONS OR GATE BURRS. 3.

4. PROTRUSIONS, OR GATE BURRS.

RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CÁSE 318** ISSUE AU

DATE 14 AUG 2024

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	2. BASE 2	E 8: 1. ANODE 2. NO CONNECTION 3. CATHODE		
STYLE 9:	STYLE 10:	2. CATHODE 2	E 12: 5	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN		1. CATHODE	PIN 1. SOURCE	PIN 1. CATHODE
2. ANODE	2. SOURCE		2. CATHODE	2. DRAIN	2. GATE
3. CATHODE	3. GATE		3. ANODE	3. GATE	3. ANODE
STYLE 15:	STYLE 16:	2. ANODE 2	E 18:	STYLE 19:	STYLE 20:
PIN 1. GATE	PIN 1. ANODE		1. NO CONNECTION	PIN 1. CATHODE	PIN 1. CATHODE
2. CATHODE	2. CATHODE		2. CATHODE	2. ANODE	2. ANODE
3. ANODE	3. CATHODE		3. ANODE	3. CATHODE-ANODE	3. GATE
STYLE 21:	STYLE 22:	2. ANODE 2	E 24: 5	STYLE 25:	STYLE 26:
PIN 1. GATE	PIN 1. RETURN		1. gate	PIN 1. ANODE	PIN 1. CATHODE
2. SOURCE	2. OUTPUT		2. drain	2. CATHODE	2. ANODE
3. DRAIN	3. INPUT		3. source	3. GATE	3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE				

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DESCRIPTION:	SOT-23 (TO-236) 2.90x1.30x1.00 1.90P		PAGE 2 OF 2

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<u>Onsemi</u>

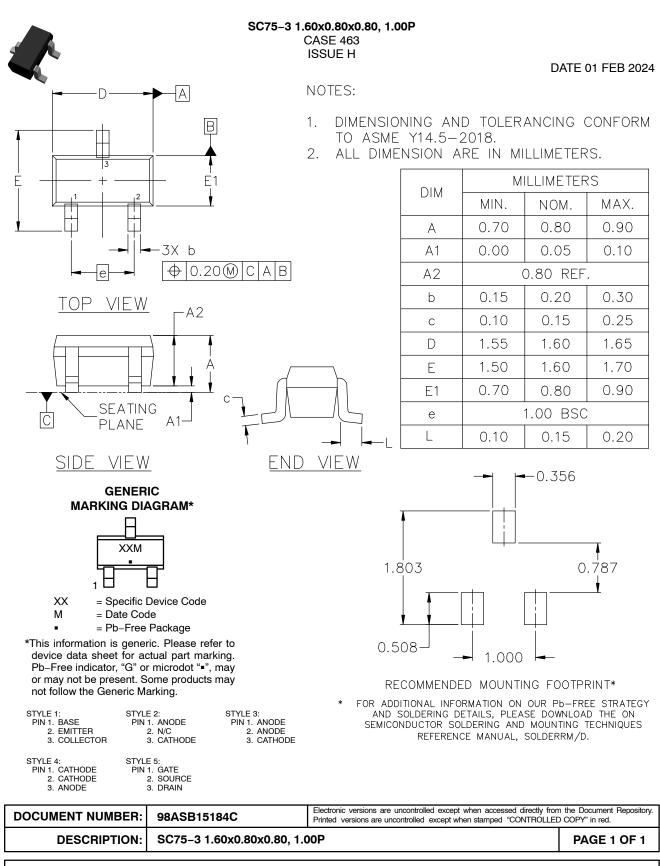
SC-70 (SOT-323) **CASE 419 ISSUE R** DATE 11 OCT 2022 SCALE 4:1 NDTES: Π DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982. 1. CONTROLLING DIMENSION: INCH 2. MILLIMETERS INCHES MIN. MIN. NDM. DIM NDM. MAX MAX. А 0.80 0.90 1.00 0.032 0.035 0.040 0.004 A1 0.00 0.05 0.10 0.000 0.002 0.70 REF 0.028 BSC Α2 b b 0.30 0.35 0.40 0.012 0.014 0.016 e 0.007 0.010 0.10 0.18 0.25 0.004 С TOP VIEW 0.080 0.087 D 1.80 2.00 2.20 0.071 E 1.15 1.24 1.35 0.045 0.049 0.053 e 1.20 1.30 1.40 0.047 0.051 0.055 0.65 BSC e1 0.026 BSC 0.05 (0.002) A2 L 0.20 0.38 0.56 0.008 0.015 0.022 Δ1 2.00 SIDE VIEW HE 2.10 2.40 0.079 0.083 0.095 END VIEW -0.65 [0.025] 0.65 [0.025]-1.90 [0.075] GENERIC **MARKING DIAGRAM** 0.90 [0.035] XX M= -0.70 [0.028] For additional information on our Pb-Free strategy and soldering details, please download the DN Seniconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D. SOLDERING FOOTPRINT XX = Specific Device Code М = Date Code = Pb-Free Package *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking. STYLE 1: CANCELLED STYLE 2: STYLE 3: STYLE 4: STYLE 5: PIN 1. ANODE 2. N.C. PIN 1. BASE PIN 1. CATHODE 2. CATHODE PIN 1. ANODE 2. EMITTER 2. ANODE 3. CATHODE 3. COLLECTOR 3. ANODE 3. CATHODE STYLE 6: STYLE 9: STYLE 10: STYLE 11: STYLE 7: STYLE 8: PIN 1. EMITTER PIN 1. BASE PIN 1. GATE PIN 1. ANODE PIN 1. CATHODE PIN 1. CATHODE 2. EMITTER 2. CATHODE 2. SOURCE 2. CATHODE 2. BASE 2. ANODE 3. COLLECTOR 3. COLLECTOR 3. DRAIN 3. CATHODE-ANODE 3. ANODE-CATHODE 3. CATHODE Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98ASB42819B Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SC-70 (SOT-323) PAGE 1 OF 1

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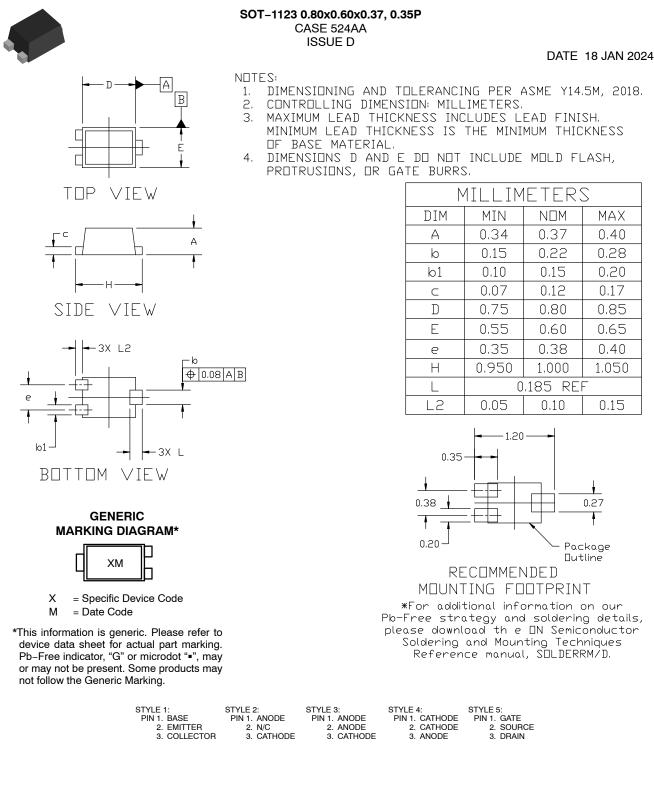
MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



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DESCRIPTION:	SOT-1123 0.80x0.60x0.37, 0.35P		PAGE 1 OF 1

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PACKAGE DIMENSIONS

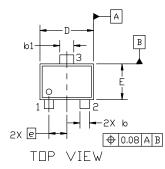


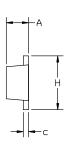
SOT-723 1.20x0.80x0.50, 0.40P CASE 631AA ISSUE E

DATE 24 JAN 2024

NDTES:

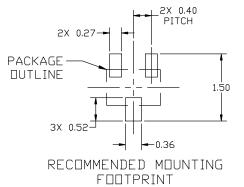
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSION: MILLIMETERS. 1.
- 2.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM З. LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4 PROTRUSIONS OR GATE BURRS.



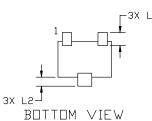


SIDE VIEW

		MILLIMETERS		
	DIM	MIN.	NDM.	MAX,
1	А	0.45	0.50	0.55
	b	0.15	0.21	0.27
	b1	0.25	0.31	0.37
	С	0.07	0.12	0.17
	D	1.15	1.20	1,25
	E	0.75	0.80	0.85
	e	0.40 BSC		
	Н	1.15	1.20	1.25
	L	0.29 REF		
	L2	0.15	0.20	0.25



*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.



GENERIC **MARKING DIAGRAM***



XX = Specific Device Code = Date Code Μ

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

2. EMITTER	LE 2: STYLE 3: N 1. ANODE PIN 1. ANODE 2. N/C 2. ANODE 3. CATHODE 3. CATHODE	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE		
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